- --61. The process of claim 60, further comprising drying the deposited material to remove said solvent.--
- --62. The process of claim 60 wherein said organic material is a luminescent polymer.--
- --63. The process of claim 60 wherein said material includes polyvinylcarbazol film.--
 - --64. The process of claim 60 wherein said solvent is chloroform.--
 - --65. The process of claim 60 wherein said material includes light emitting dyes.--
- --66. The process of claim 65 wherein said light emitting dyes include coumarin and nile red.--
 - --67. The process of claim 66 wherein said coumarin is coumarin 6.--
 - --68. The process of claim 66 wherein said coumarin is coumarin 47.--
- --69. The process of claim 66 wherein said coumarin is coumarin 6 and coumarin 47.--
- --70. The process of claim 60 wherein said organic material is a mixture of polymers and other organic molecules.--
- --71. A process for making organic light emitting diodes comprising the steps of:

 depositing a semiconducting organic material in a solvent onto a substrate by
 ink-jet printing; and

evaporating the solvent, said organic material remaining on the substrate.--

- --72. The process of claim 71 wherein said depositing step operates an ink-jet printer in a mode to create a continuous sheet of polymer.--
- --73. The process of claim 72 further including the step of metallizing said ink-jet printed substrates.--

- --74. The process of claim 73 further including the step of depositing with ink-jet printing top metal contacts on said substrate.--
- --75. The process of claim 74 wherein said top metal contacts are deposited through a shadow mask.--
- --76. The process of claim 71 further including the step of depositing with ink-jet printing bottom metal contacts on said substrate.--
- --77. The process of claim 74 wherein said top metal contacts are deposited in a pattern.--
- --78. The process of claim 76 wherein said bottom metal contacts are deposited in a pattern.--
- --79. The process of claim 71 further wherein said organic material includes light emitting dyes.--
- --80. The process of claim 79 further including the step of depositing top contacts on said organic material by ink jet printing.--
- --81. The process of claim 80 further including the step of depositing bottom contacts on said substrate by ink-jet printing.--
 - --82. A process of forming thin film field effect transistors comprising the steps of: forming a gate electrode on a substrate;

forming a gate insulator over said gate electrode;

forming a polymer semiconducting layer on said insulator by ink-jet printing;

and

forming source and drain contacts on said semiconducting layer.--

--83. The process of claim 82 wherein said gate insulator is formed by ink-jet printing, and the semiconducting layer by other techniques.--

- --84. The process of claim 82 wherein the source and drain contacts are applied directly on the gate insulator before the semiconducting layer is deposited.--
- --85. The process of claim 83 wherein the source and drain contacts are applied directly on the gate insulator before the semiconducting layer is deposited.--
- --86. The process of claim 82 wherein the semiconducting layer comprises a non-polymeric organic film or a polymer/small organic molecule blend.--
- --87. The process of claim 83 wherein the semiconducting layer comprises a non-polymeric organic film or a polymer/small organic molecule blend.--
- --88. The process of claim 84 wherein the semiconducting layer comprises a non-polymeric organic film or a polymer/small organic molecule blend.--
- --89. A process for forming a pattern on a substrate by deposition of an organic material comprising the steps of:

depositing organic material including polyvinylcarbazol film in a solvent onto a substrate by ink-jet printing; and

evaporating the solvent, whereby said organic material remains on the substrate.--

- --90. The process of claim 89, further comprising drying the deposited material to remove said solvent.--
 - --91. The process of claim 89 wherein said organic material is semiconducting.--
- --92. The process of claim 89 wherein said organic material is a luminescent polymer.--
 - --93. The process of claim 89 wherein said solvent is chloroform.--
 - --94. The process of claim 89 wherein said material includes light emitting dyes.--
- --95. The process of claim 94 wherein said light emitting dyes include coumarin and nile red.--

- --96. The process of claim 95 wherein said coumarin is coumarin 6.--
- --97. The process of claim 95 wherein said coumarin is coumarin 47.--
- --98. The process of claim 95 wherein said coumarin is coumarin 6 and coumarin 47.--
- --99. The process of claim 89 wherein said organic material is a mixture of polymers and other organic molecules.--
- --100. A process for making organic light emitting diodes comprising the steps of:

 depositing organic material including polyvinylcarbazol film in a solvent onto
 a substrate by ink-jet printing; and

evaporating the solvent, said organic material remaining on the substrate.--

- --101. The process of claim 100 wherein said depositing step operates an ink-jet printer in a mode to create a continuous sheet of polymer.--
- --102. The process of claim 101 further including the step of metallizing said ink-jet printed substrates.--
- --103. The process of claim 102 further including the step of depositing with ink-jet printing top metal contacts on said substrate.--
- --104. The process of claim 103 wherein said top metal contacts are deposited through a shadow mask.--
- --105. The process of claim 100 further including the step of depositing with ink-jet printing bottom metal contacts on said substrate.--
- --106. The process of claim 103 wherein said top metal contacts are deposited in a pattern.--
- --107. The process of claim 105 wherein said bottom metal contacts are deposited in a pattern.--